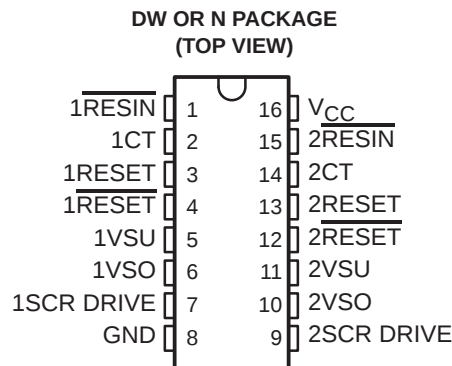


- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- $\overline{\text{RESET}}$ Defined When V_{CC} Exceeds 1 V
- Wide Supply-Voltage Range . . . 3.5 V to 18 V
- Precision Overvoltage and Undervoltage Sensing
- 250-mA Peak Output Current for Driving SCR Gates
- 2-mA Active-Low SCR Gate Drive for False-Trigger Protection
- Temperature-Compensated Voltage Reference
- True and Complementary Reset Outputs
- Externally Adjustable Output Pulse Duration



description

The TL7770 is an integrated-circuit system supervisor designed for use as a reset controller in microcomputer and microprocessor power-supply systems. This device contains two independent supply-voltage supervisors that monitor the supplies for overvoltage and undervoltage conditions at the VSO and VSU terminals, respectively. When V_{CC} attains the minimum voltage of 1 V during power up, the $\overline{\text{RESET}}$ output becomes active (low). As V_{CC} approaches 3.5 V, the time-delay function activates, latching RESET and $\overline{\text{RESET}}$ active (high and low, respectively) for a time delay (t_d) after system voltages have achieved normal levels. Above $V_{CC} = 3.5$ V, taking $\overline{\text{RESIN}}$ low activates the time-delay function during normal system-voltage levels. To ensure that the microcomputer system has reset, the outputs remain active until the voltage at VSU exceeds the threshold value, V_{IT+} , for a time delay, which is determined by an external timing capacitor such that:

$$t_d \approx 20 \times 10^3 \times \text{capacitance}$$

where t_d is in seconds and capacitance is in farads.

The overvoltage-detection circuit is programmable for a wide range of designs. During an overvoltage condition, an internal silicon-controlled rectifier (SCR) is triggered, providing 250-mA peak instantaneous current and 25-mA continuous current to the SCR gate drive terminal, which can drive an external high-current SCR gate or an overvoltage-warning circuit.

The TL7770C series is characterized for operation from 0°C to 70°C. The TL7770I series is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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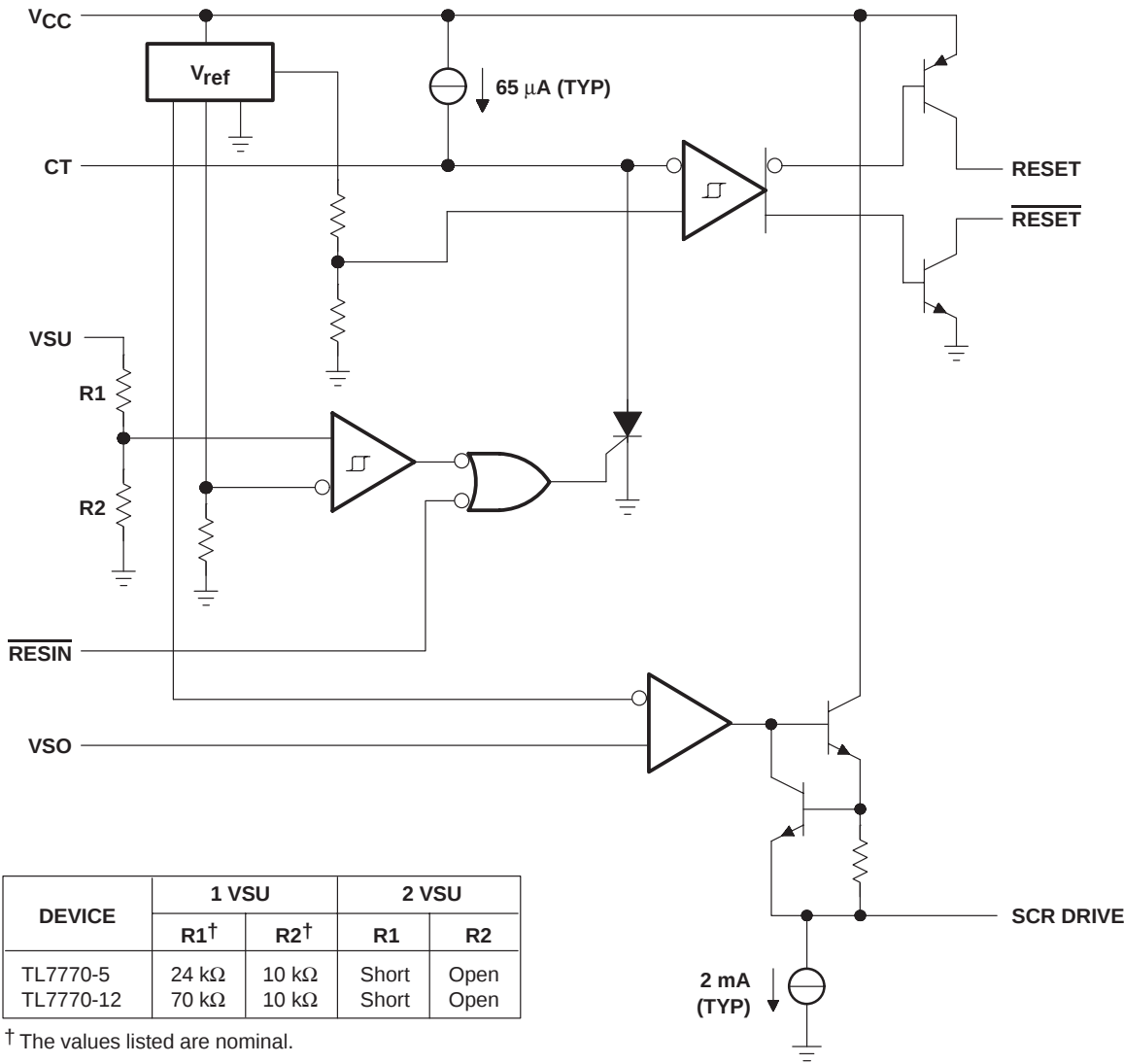
TL7770-5, TL7770-12 DUAL POWER-SUPPLY SUPERVISORS

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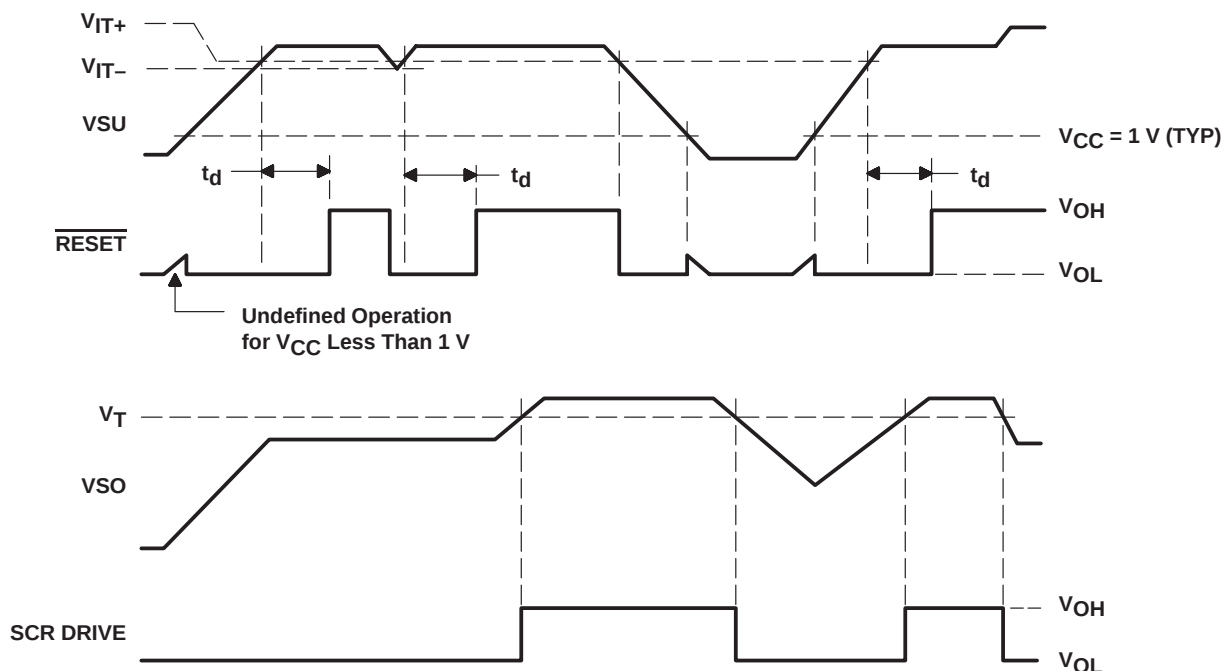
AVAILABLE OPTIONS			
T _A	PACKAGED DEVICES		CHIP FORM (Y)
	SMALL OUTLINE (DW)	PLASTIC DIP (N)	
0°C to 70°C	TL7770-5CDW TL7770-12CDW	TL7770-5CN TL7770-12CN	TL7770-5Y TL7770-12Y
–40°C to 85°C	TL7770-5IDW	TL7770-5IN	—

DW package is available taped and reeled. Add the suffix R to the device type (e.g., TL7770-5CDWR). Chip forms are tested at 25°C.

functional block diagram (each channel)



timing requirements



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC} (see Note 1)	20 V
Input voltage range, V_I : 1VSU, 2VSU, 1VSO, and 2VSO (see Note 1)	–0.3 V to 18 V
Low-level output current (1RESET and 2RESET), I_{OL}	20 mA
High-level output current (1RESET and 2RESET), I_{OH}	–20 mA
Package thermal impedance, θ_{JA} (see Notes 2 and 3): DW package	57°C/W
N package	88°C/W
Lead temperature 1,6 mm (1/16 in) from case for 10 seconds: DW or N package	260°C
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values are with respect to the network ground terminal.
 2. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 3. The package thermal impedance is calculated in accordance with JEDEC 51, except for through-hole packages, which use a trace length of zero.

TL7770-5, TL7770-12

DUAL POWER-SUPPLY SUPERVISORS

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recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V_{CC}		3.5	18	V
Input voltage range, V_I (see Note 4)	1VSU, 2VSU, 2VSO, 1VSO	0	18	V
Output voltage, V_O (1CT, 2CT)			5	V
High-level input voltage range, V_{IH} ($\overline{1RESIN}$, $\overline{2RESIN}$)		2	18	V
Low-level input voltage range, V_{IL} ($\overline{1RESIN}$, $\overline{2RESIN}$)		0	0.8	V
Output sink current, I_O (1CT, 2CT)			50	μA
High-level output current, I_{OH} ($\overline{1RESET}$, $\overline{2RESET}$)			–16	mA
Low-level output current, I_{OL} ($\overline{1RESET}$, $\overline{2RESET}$)			16	mA
Continuous output current, I_O (1SCR DRIVE, 2SCR DRIVE)			25	mA
Timing capacitor, C_T			10	μF
Operating free-air temperature, T_A	TL7770C series	0	70	$^{\circ}C$
	TL7770I series	–40	85	$^{\circ}C$

NOTE 4: The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.



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TL7770-5, TL7770-12 DUAL POWER-SUPPLY SUPERVISORS

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electrical characteristics over recommended operating conditions (unless otherwise noted)

supply supervisor section

PARAMETER			TEST CONDITIONS†	TL7770-5C TL7770-12C TL7770-5I			UNIT
				MIN	TYP‡	MAX	
VOH	High-level output voltage	RESET	IOH = −15 mA	VCC−1.5		V	
		SCR DRIVE	IOH = −20 mA	VCC−1.5			
VOL	Low-level output voltage	RESET	IOL = 15 mA	0.4		V	
VIT−	Undervoltage input threshold at VSU (negative-going)	TL7770-5 (5-V sense, 1VSU)	TA = MIN to MAX	4.46	4.64	V	
		TL7770-12 (12-V sense, 1VSU)		10.68	11.12		
		TL7770-5, TL7770-12 (programmable sense, 2VSU)		1.47	1.53		
Vhys	Hysteresis at VSU (VIT+ − VIT−)	TL7770-5 (5-V sense, 1VSU)	TA = MIN to MAX	15		mV	
		TL7770-12 (12-V sense, 1VSU)		36			
		TL7770-5, TL7770-12 (programmable sense, 2VSU)		5			
VT	Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	TA = MIN to MAX	2.48	2.68	V	
II	Input current	RESIN	VI = 5.5 V or 0.4 V	−10		μA	
		VSO	VI = 2.4 V	0.5 2			
IOH	High-level output current	RESET	VO = 18 V	50		μA	
IOL	Low-level output current	RESET	VO = 0	−50		μA	
IOH	Peak output current	SCR DRIVE	Duration = 1 ms	250		mA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.

[‡] Typical values are at V_{CC} = 5 V, T_A = 25°C.

total device

PARAMETER		TEST CONDITIONS [†]		TL7770-5C TL7770-12C TL7770-5I			UNIT
				MIN	TYP [‡]	MAX	
V _{res} [§]	Power-up reset voltage	V _{CC} = V _{SU}		0.8	1		V
I _{CC}	Supply current	1V _{SU} = 18 V, 2V _{SU} = 2 V, 1R _{ESIN} and 2R _{ESIN} at V _{CC} , 1V _{SO} and 2V _{SO} at 0 V	T _A = 25°C	5			mA
			T _A = MIN to MAX	6.5			

[†] For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.

[‡] Typical values are at V_{CC} = 5 V, T_A = 25°C.

[§] This is the lowest voltage at which RESET becomes active.



TL7770-5, TL7770-12

DUAL POWER-SUPPLY SUPERVISORS

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electrical characteristics over recommended operating conditions (unless otherwise noted)

supply supervisor section

PARAMETER		TEST CONDITIONS	TL7770-5Y TL7770-12Y			UNIT
			MIN	TYP [†]	MAX	
V_{IT-} Undervoltage input threshold at VSU (negative-going)	TL7770-5 (5-V sense, 1VSU)	$T_A = \text{MIN to MAX}$	4.46		4.64	V
	TL7770-12 (12-V sense, 1VSU)		10.68		11.12	
	TL7770-5, TL7770-12 (programmable sense, 2VSU)		1.47		1.53	
V_{hys} Hysteresis at VSU ($V_{IT+} - V_{IT-}$)	TL7770-5 (5-V sense, 1VSU)	$T_A = \text{MIN to MAX}$		15		mV
	TL7770-12 (12-V sense, 1VSU)			36		
	TL7770-5, TL7770-12 (programmable sense, 2VSU)			5		
V_T Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	$T_A = \text{MIN to MAX}$	2.48		2.68	V
I_I Input current	VSO	$V_I = 2.4 \text{ V}$		0.5		μA

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

total device

PARAMETER		TEST CONDITIONS	TL7770-5Y TL7770-12Y			UNIT
			MIN	TYP [†]	MAX	
$V_{res}^{\ddagger}$ Power-up reset voltage		$V_{CC} = \text{VSU}$, $V_{OL} = 0.4 \text{ V}$, $I_{OL} = 1 \text{ mA}$		0.8		V
I_{CC} Supply current		$1\text{VSU} = 18 \text{ V}$, $2\text{VSU} = 2 \text{ V}$, 1RESIN and 2RESIN at V_{CC} , 1VSO and 2VSO at 0 V			5	mA

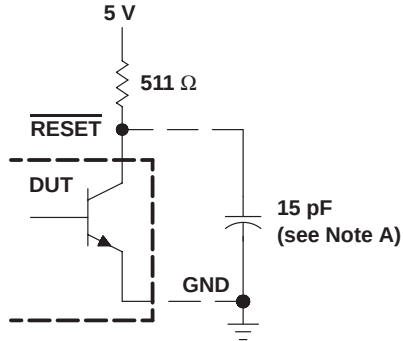
[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

[‡] This is the lowest voltage at which RESET becomes active.

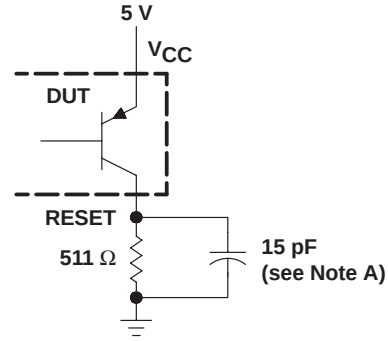
switching characteristics, $V_{CC} = 5 \text{ V}$, C_T open, $T_A = 25^\circ\text{C}$

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	$\overline{\text{RESIN}}$	RESET	See Figures 1 and 3		270	500	ns
t_{PHL}	Propagation delay time, high-to-low-level output	$\overline{\text{RESIN}}$	$\overline{\text{RESET}}$			270	500	ns
t_r	Rise time		RESET				75	ns
t_f	Fall time		RESET			150		
t_r	Rise time		$\overline{\text{RESET}}$			75		ns
t_f	Fall time		$\overline{\text{RESET}}$				50	
$t_{w(\text{min})}$	Minimum effective pulse duration	$\overline{\text{RESIN}}$		See Figure 2a		150		ns
		VSU		See Figure 2b		100		

PARAMETER MEASUREMENT INFORMATION



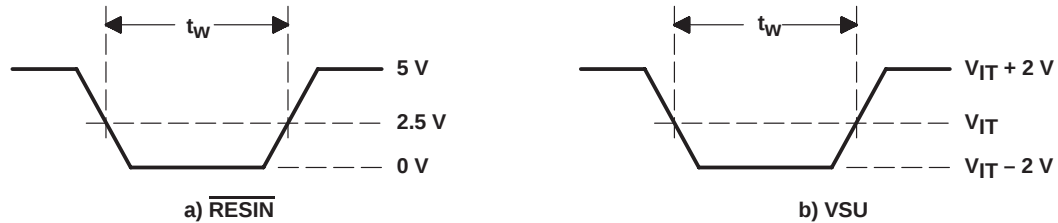
RESET OUTPUT CONFIGURATION



RESET OUTPUT CONFIGURATION

NOTE A: This includes jig and probe capacitance.

Figure 1. $\overline{\text{RESET}}$ and RESET Output Configurations



WAVEFORMS

Figure 2. Input Pulse Definition

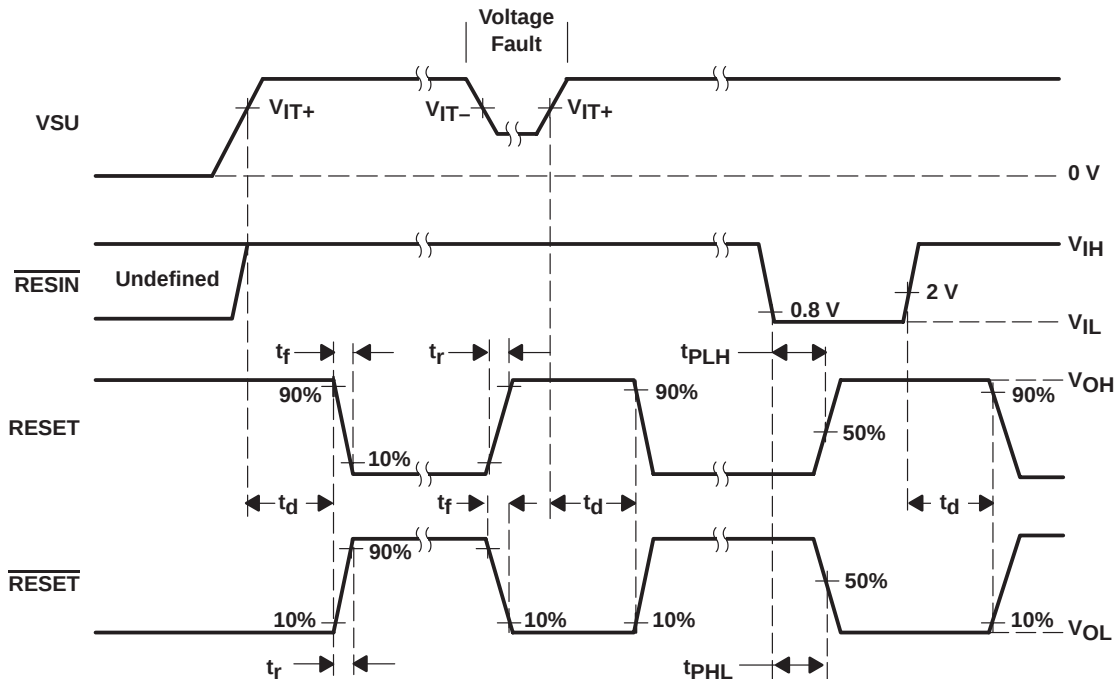


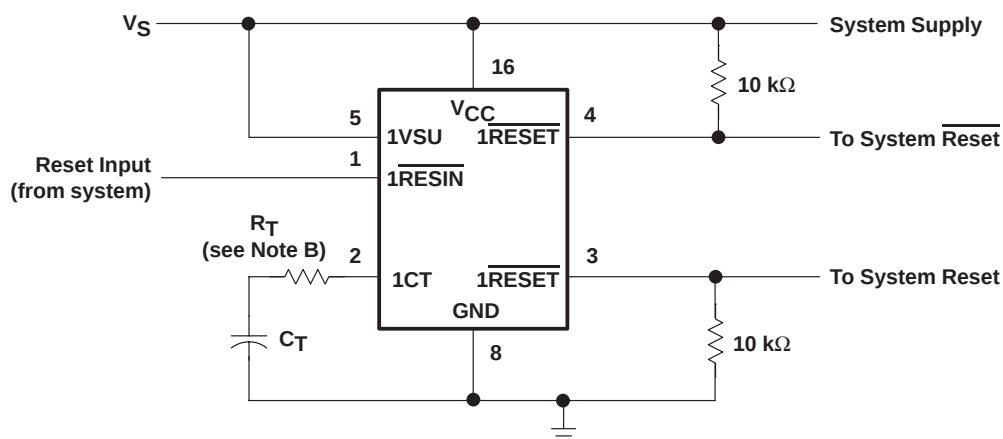
Figure 3. Voltage Waveforms

TL7770-5, TL7770-12

DUAL POWER-SUPPLY SUPERVISORS

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APPLICATION INFORMATION



NOTE B: When V_{CC} and 1VSU are connected to the same point, it is recommended that series resistance (R_T) be added between the time-delay programming capacitor (C_T) and the voltage-supervisor device terminal (1CT). The suggested R_T value is given by:

$$R_T > \frac{V_I - V_{IT-}}{1 \times 10^{-3}}, \text{ where } V_I = (\text{the lesser of } 7.1 \text{ V or } V_S)$$

When this series resistor is used, the t_d calculation is as follows:

$$t_d = \frac{1.3 - [(6.5E - 5) \times 10^{-5}] \times R_T}{6.5 \times 10^{-5}} \times C_T$$

Figure 4. System Reset Controller With Undervoltage Sensing

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TL7770-12CDWR	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	7770-12C
TL7770-12CDWR.A	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	7770-12C
TL7770-5CDWR	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL7770-5C
TL7770-5CDWR.A	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL7770-5C
TL7770-5CN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TL7770-5CN
TL7770-5CN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	TL7770-5CN
TL7770-5IDW	Obsolete	Production	SOIC (DW) 16	-	-	Call TI	Call TI	-40 to 85	TL7770-5I
TL7770-5IDWR	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL7770-5I
TL7770-5IDWR.A	Active	Production	SOIC (DW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL7770-5I

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL7770-12CDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
TL7770-5CDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
TL7770-5IDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL7770-12CDWR	SOIC	DW	16	2000	350.0	350.0	43.0
TL7770-5CDWR	SOIC	DW	16	2000	350.0	350.0	43.0
TL7770-5IDWR	SOIC	DW	16	2000	350.0	350.0	43.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
TL7770-5CN	N	PDIP	16	25	506	13.97	11230	4.32
TL7770-5CN.A	N	PDIP	16	25	506	13.97	11230	4.32

GENERIC PACKAGE VIEW

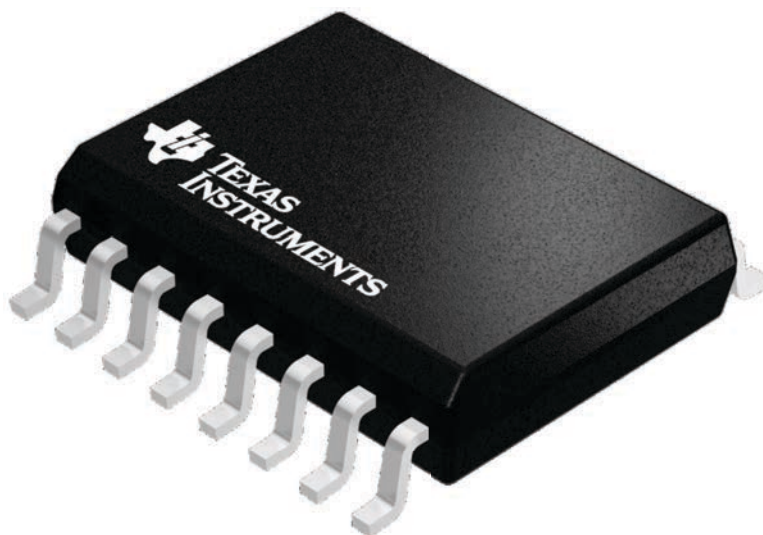
DW 16

SOIC - 2.65 mm max height

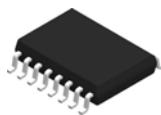
7.5 x 10.3, 1.27 mm pitch

SMALL OUTLINE INTEGRATED CIRCUIT

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4224780/A

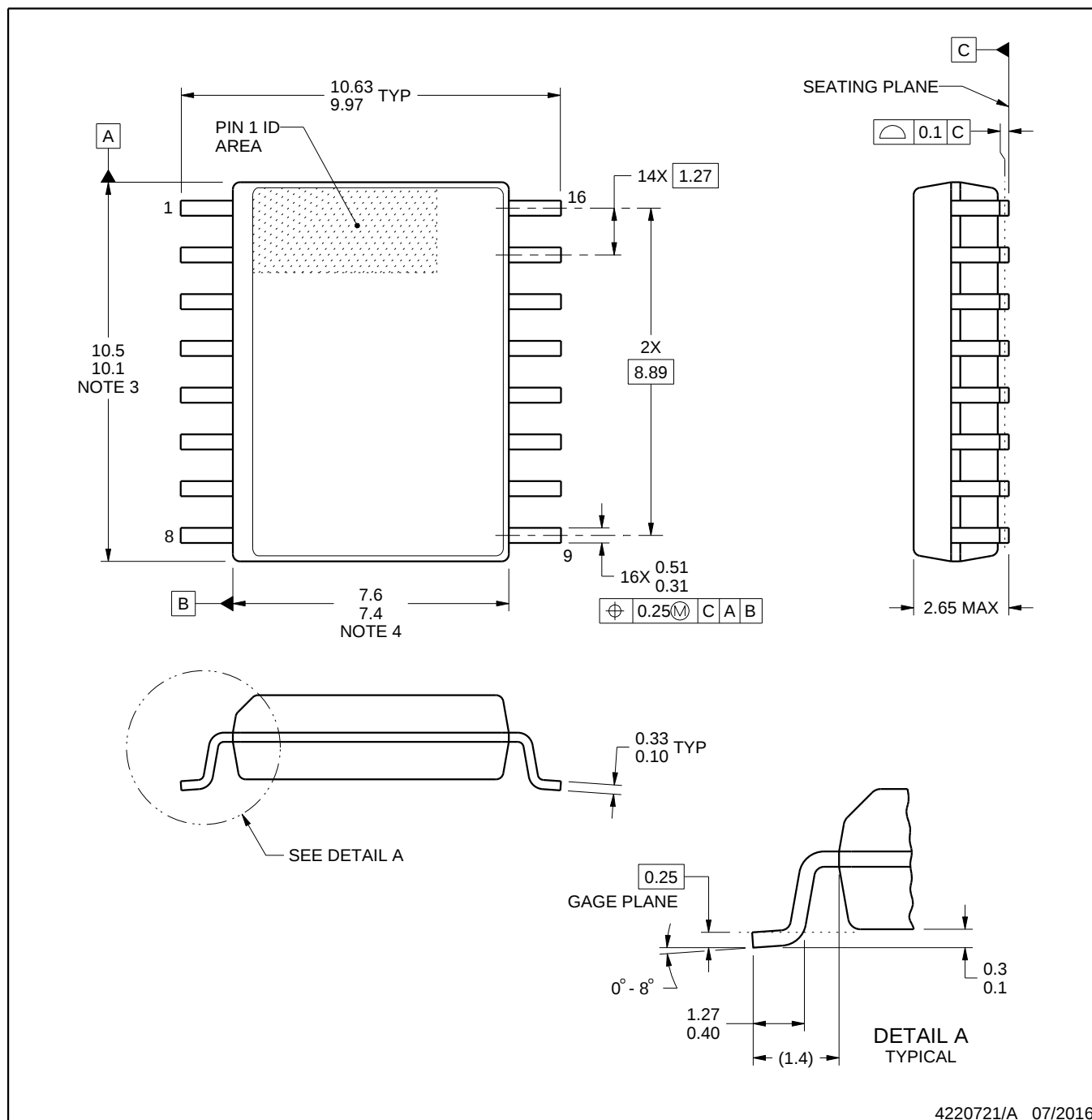


DW0016A

PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220721/A 07/2016

NOTES:

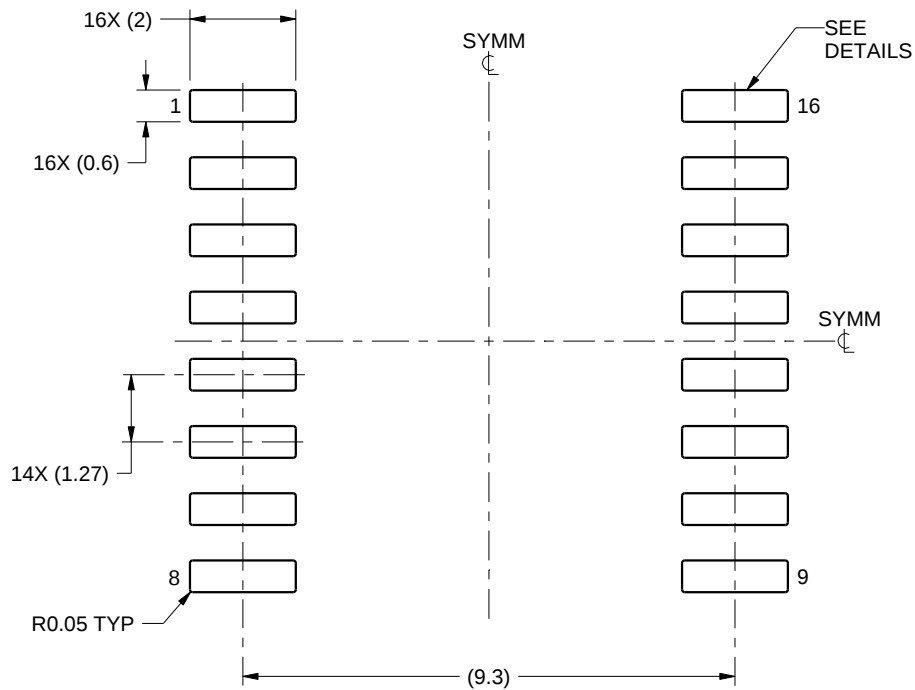
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

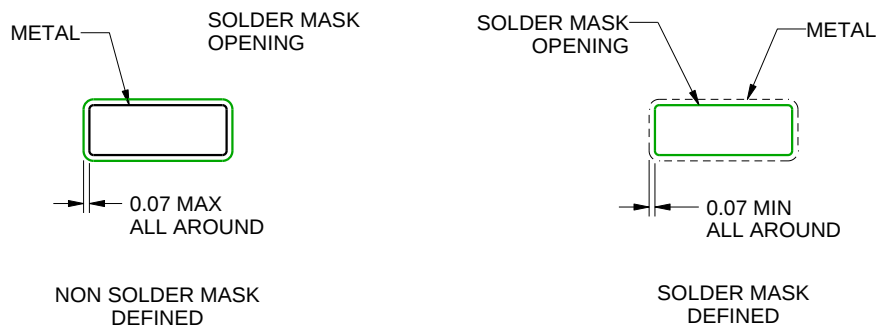
DW0016A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:7X



SOLDER MASK DETAILS

4220721/A 07/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

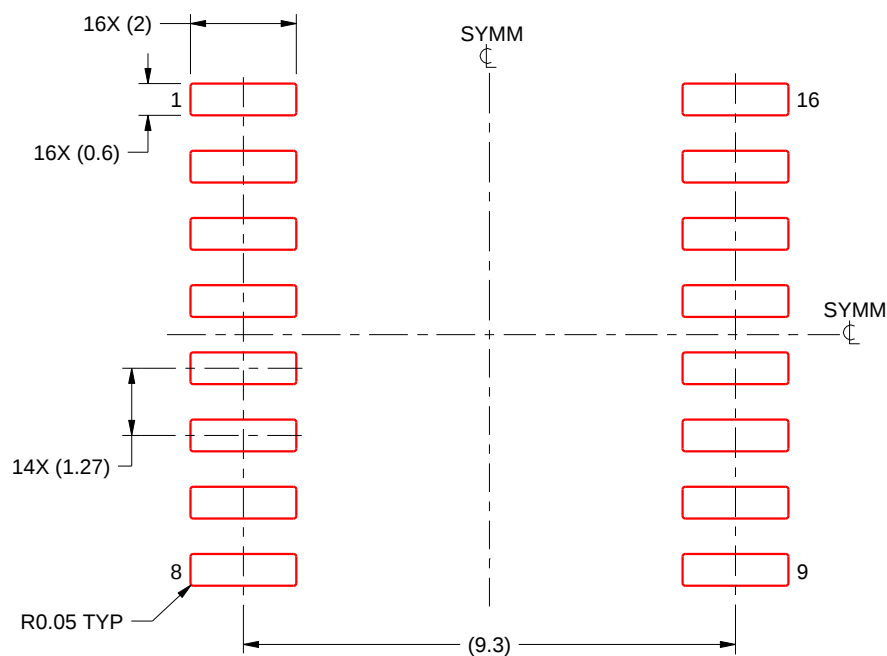
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0016A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220721/A 07/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

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